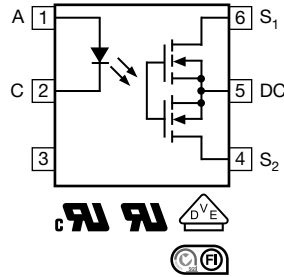


1 Form A Solid-State Relay (Normally Open)



FEATURES

- Isolation test voltage 5300 V_{RMS}
- Typical R_{ON} 22 Ω
- Load voltage 350 V
- Load current 120 mA / 250 mA
- Clean bounce free switching
- Low power consumption
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

APPLICATIONS

- General telecom switching
- Security equipment
- Instrumentation
- Industrial controls

LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

The LH1540 is robust, ideal for telecom and ground fault applications. It is an SPST normally open switch (1 Form A) that replaces electromechanical relays in many applications. It is constructed using a GaAs LED for actuation control and MOSFETs for the switch output.

AGENCY APPROVALS

- [UL](#)
- [cUL](#)
- [DIN EN 60747-5-5 \(VDE 0884\)](#)
- [FIMKO](#)

ORDERING INFORMATION		
<div style="display: flex; justify-content: space-around; align-items: center;"> <div style="border: 1px solid black; padding: 2px 5px;">L</div> <div style="border: 1px solid black; padding: 2px 5px;">H</div> <div style="border: 1px solid black; padding: 2px 5px;">1</div> <div style="border: 1px solid black; padding: 2px 5px;">5</div> <div style="border: 1px solid black; padding: 2px 5px;">4</div> <div style="border: 1px solid black; padding: 2px 5px;">0</div> <div style="border: 1px solid black; padding: 2px 5px;">#</div> <div style="border: 1px solid black; padding: 2px 5px;">#</div> <div style="border: 1px solid black; padding: 2px 5px;">#</div> <div style="border: 1px solid black; padding: 2px 5px;">T</div> <div style="border: 1px solid black; padding: 2px 5px;">R</div> </div>		
PART NUMBER	ELECTR. VARIATION	PACKAGE CONFIG.
		TAPE AND REEL
PACKAGE	UL, cUL, FIMKO, VDE	
SMD-6, tube	LH1540AAB	LH1540AAB-X001
SMD-6, tape and reel	LH1540AABTR	-
DIP-6, tube	LH1540AT	LH1540AT-X001



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	CONDITION	SYMBOL	VALUE	UNIT
INPUT				
IRED continuous forward current		I _F	50	mA
IRED reverse voltage		V _R	5	V
Input power dissipation		P _{diss}	80	mW
OUTPUT				
DC or peak AC load voltage		V _L	350	V
Continuous load current (AC/DC configuration)		I _L	120	mA
Continuous load current (DC only configuration)		I _L	250	mA
SSR output power dissipation (continuous)		P _{diss}	550	mW
SSR				
Ambient temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +150	°C
Soldering temperature	t = 10 s max.	T _{slid}	260	°C

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
IRED forward current, switch turn-on	I _L = 100 mA, t = 10 ms	I _{Fon}	-	0.3	2	mA
IRED forward current, switch turn-off	V _L = 350 V	I _{Foff}	0.05	0.15	-	mA
IRED forward voltage	I _F = 10 mA	V _F	-	1.4	1.6	V
OUTPUT						
On-resistance (AC/DC configuration)	I _F = 5 mA, I _L = 50 mA	R _{ON}	-	22	27	Ω
On-resistance (DC only configuration)	I _F = 5 mA, I _L = 100 mA	R _{ON}	-	5.2	7	Ω
Off-resistance	I _F = 0 mA, V _L = ± 100 V	R _{OFF}	0.5	5000	-	GΩ
Off-state leakage current	I _F = 0 mA, V _L = ± 100 V	I _O	-	< 1	200	nA
	I _F = 0 mA, V _L = ± 350 V	I _O	-	6	1000	nA
Output capacitance (AC/DC configuration)	I _F = 0 mA, V _L = 1 V, 1 MHz	C _O	-	39	-	pF
	I _F = 0 mA, V _L = 50 V, 1 MHz	C _O	-	6	-	pF
TRANSFER						
Capacitance (input to output)	V _{ISO} = 1 V	C _{IO}	-	0.4	-	pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

PIN CONFIGURATION

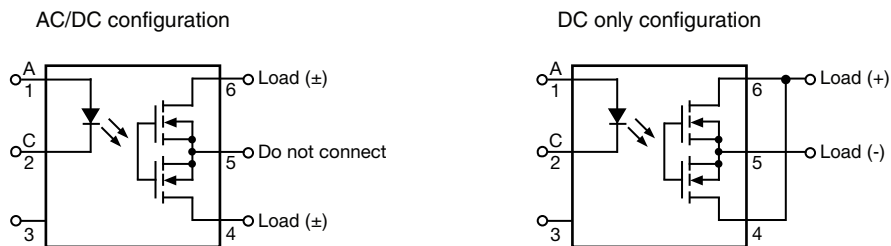


Fig. 1 - Pin Configuration

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	t_{on}	-	0.13	2	ms
Turn-off time	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	t_{off}	-	0.05	2	ms

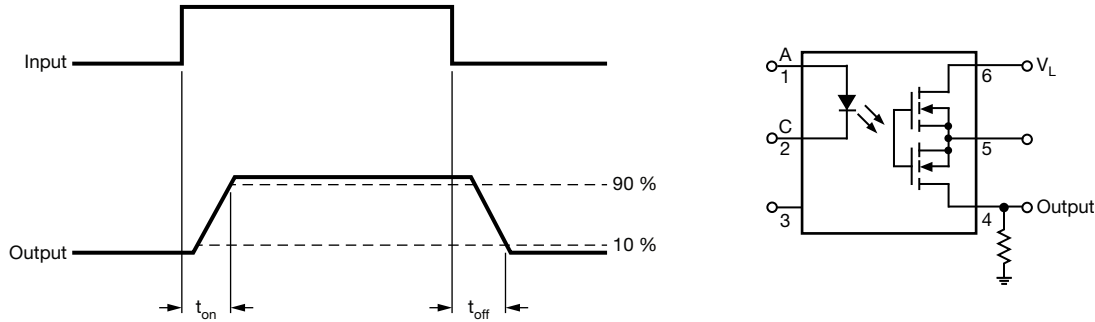


Fig. 2 - Timing Schematic

SAFETY AND INSULATION RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		40 / 85 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	V_{ISO}	5300	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V_{IOTM}	8000	V_{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V_{IORM}	890	V_{peak}
Isolation resistance	$V_{IO} = 500\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	R_{IO}	$\geq 10^{12}$	Ω
	$V_{IO} = 500\text{ V}$, $T_{amb} = 100\text{ }^{\circ}\text{C}$	R_{IO}	$\geq 10^{11}$	Ω
Output safety power		P_{SO}	700	mW
Input safety current		I_{SI}	240	mA
Safety temperature		T_S	175	$^{\circ}\text{C}$
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Insulation thickness		DTI	≥ 0.4	mm
Input to output test voltage, method B	$V_{IORM} \times 1.875 = V_{PR}$, 100 % production test with $t_M = 1\text{ s}$, partial discharge $< 5\text{ pC}$	V_{PR}	1669	V_{peak}
Input to output test voltage, method A	$V_{IORM} \times 1.6 = V_{PR}$, 100 % sample test with $t_M = 10\text{ s}$, partial discharge $< 5\text{ pC}$	V_{PR}	1424	V_{peak}

Note

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

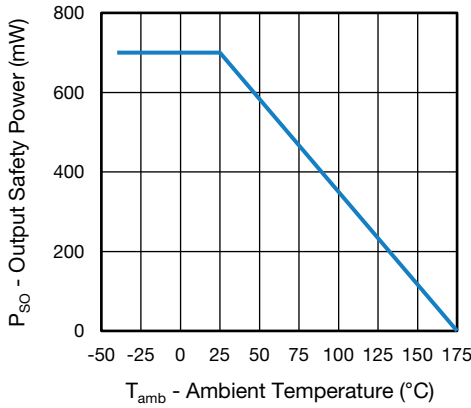


Fig. 3 - Safety Power Dissipation vs. Ambient Temperature

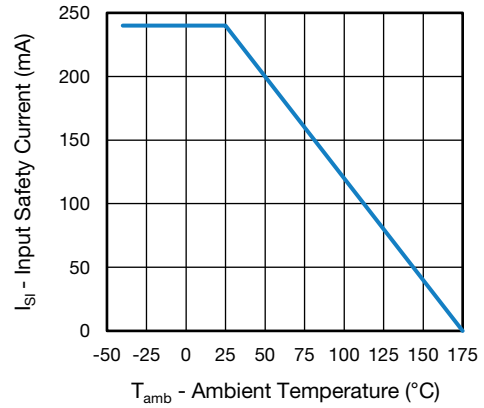


Fig. 4 - Safety Input Current vs. Ambient Temperature

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

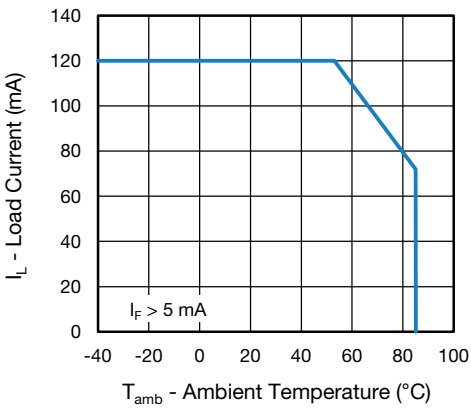


Fig. 5 - Maximum Load Current vs. Ambient Temperature

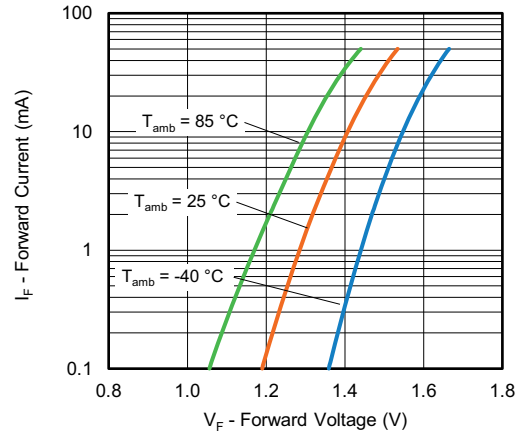


Fig. 7 - Forward Current vs. Forward Voltage

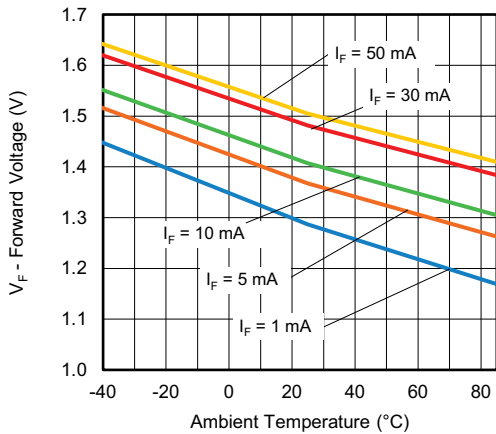


Fig. 6 - Forward Voltage vs. Ambient Temperature

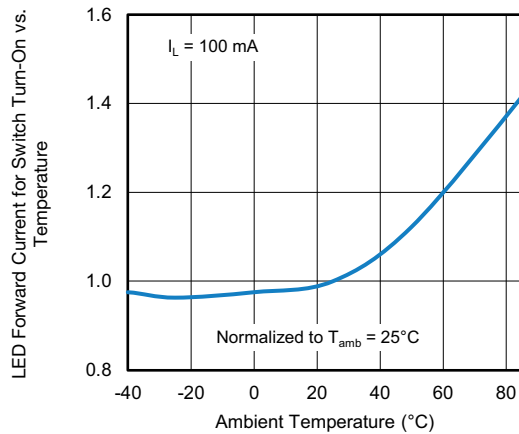


Fig. 8 - Normalized Forward Current for Switch Turn-On vs. Ambient Temperature

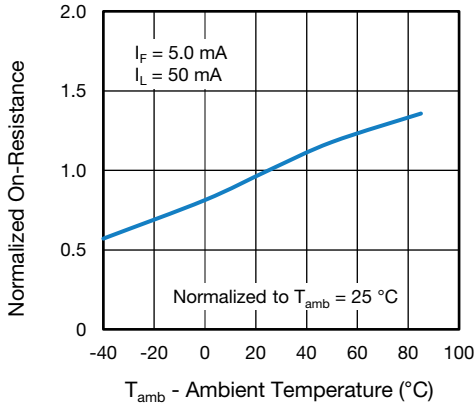


Fig. 9 - Normalized On-Resistance vs. Ambient Temperature

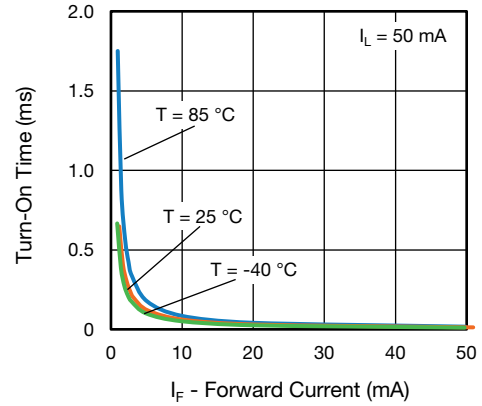


Fig. 12 - Turn-On Time vs. Forward Current

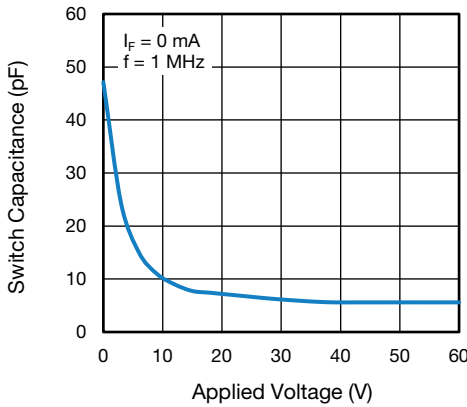


Fig. 10 - Switch Capacitance vs. Applied Voltage

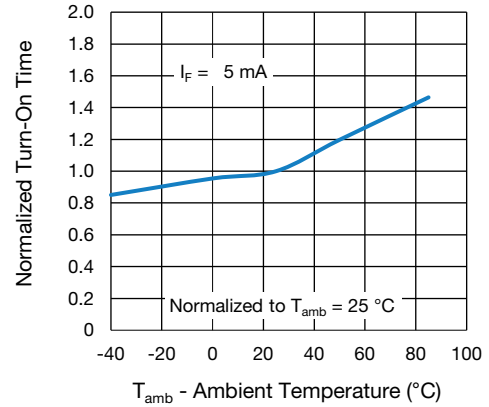


Fig. 13 - Normalized Turn-On Time vs. Ambient Temperature

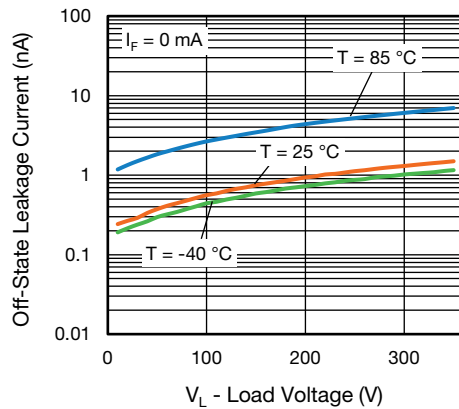


Fig. 11 - Off-State Leakage Current vs. Load Voltage

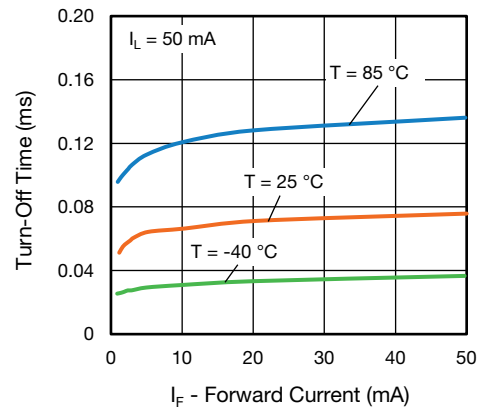


Fig. 14 - Turn-Off Time vs. Forward Current

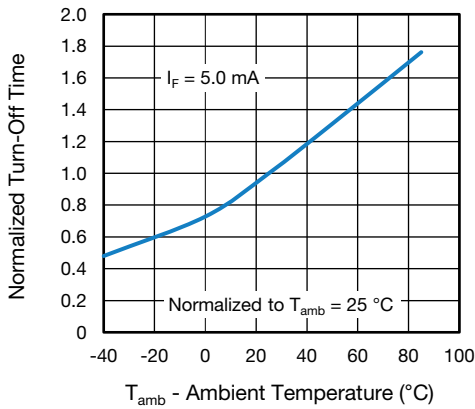
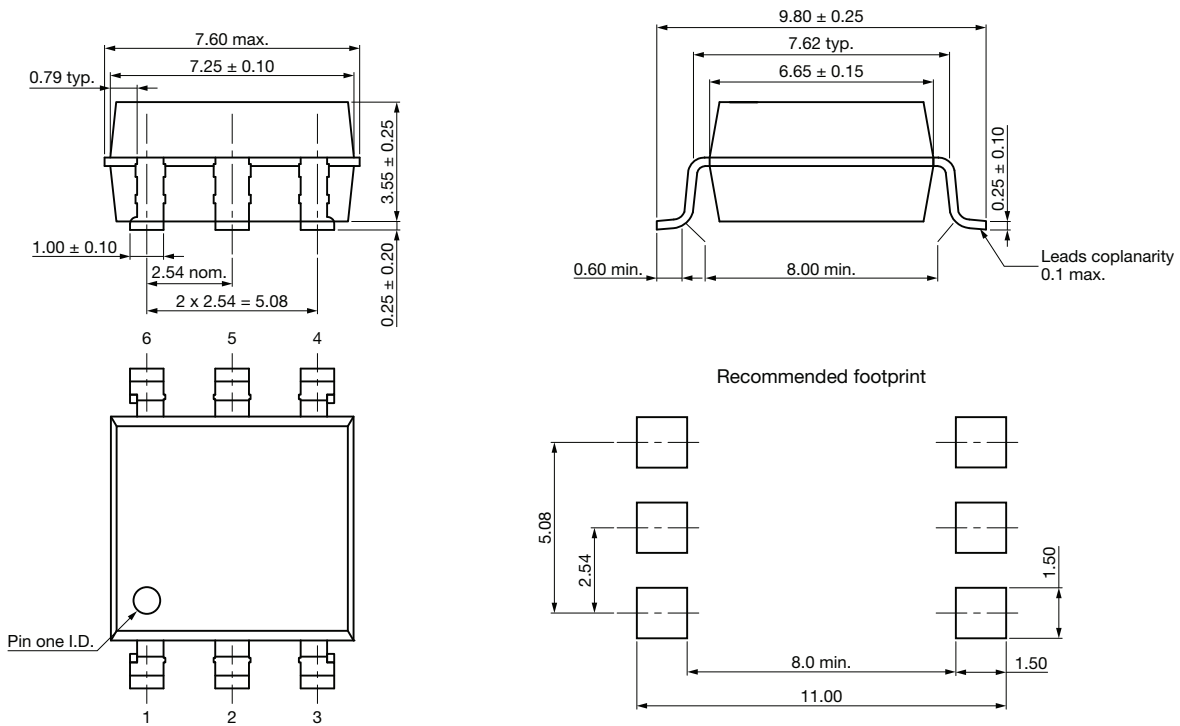


Fig. 15 - Normalized Turn-Off Time vs. Ambient Temperature

PACKAGE DIMENSIONS (in millimeters)

SMD-6



DIP-6

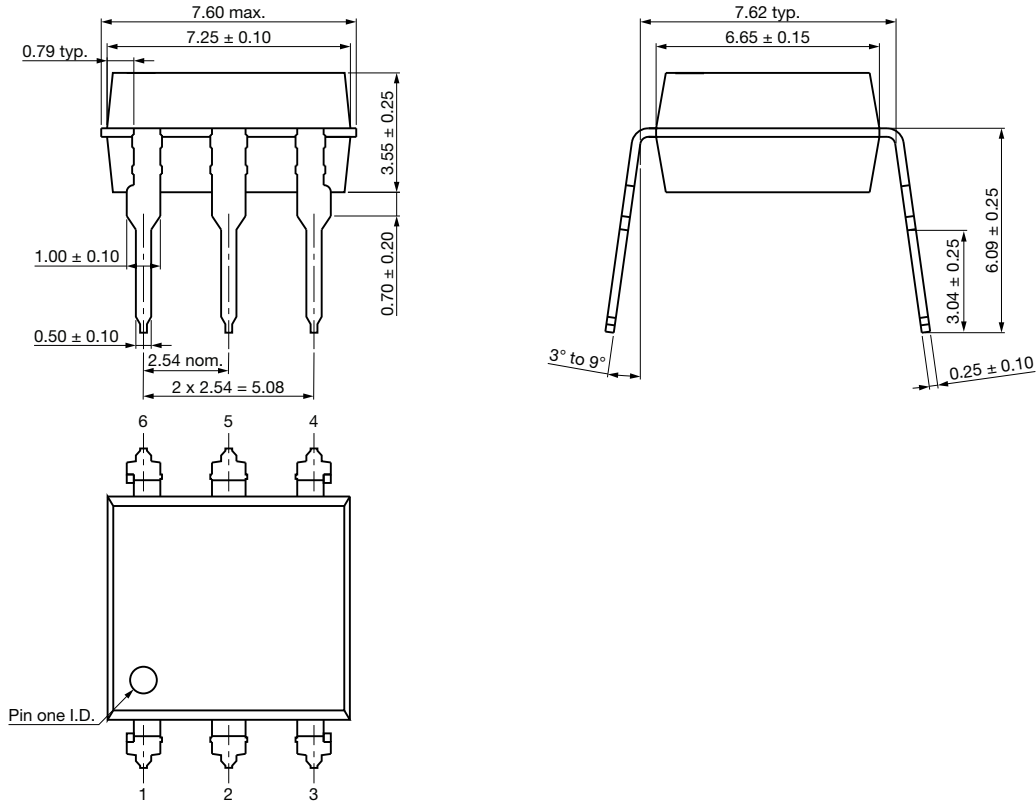


Fig. 16 - Package Drawings

PACKAGE MARKING

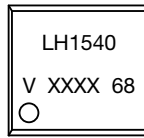
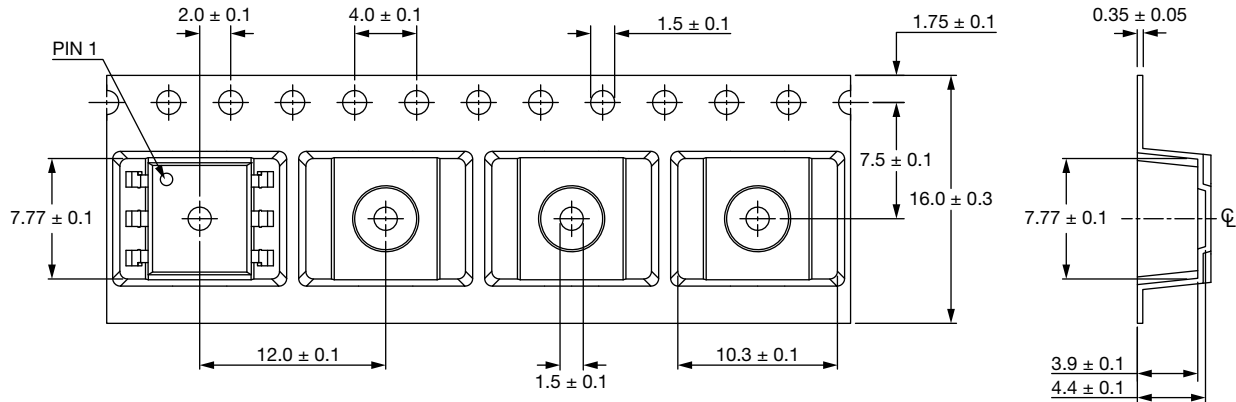


Fig. 17 - LH1540

Notes

- XXXX = LMC (lot marking code)
- Tape and reel suffix (TR) is not part of the package marking

PACKING INFORMATION (in millimeters)



Note:

- Cumulative tolerance of 10 spocket holes is 0.20 mm

Fig. 18 - Tape and Reel Packing

TAPE AND REEL PACKING	
TYPE	UNITS/REEL
SMD-6	1000

TUBE PACKING			
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX
SMD-6	50	40	2000
DIP-6	50	40	2000

SOLDER PROFILES

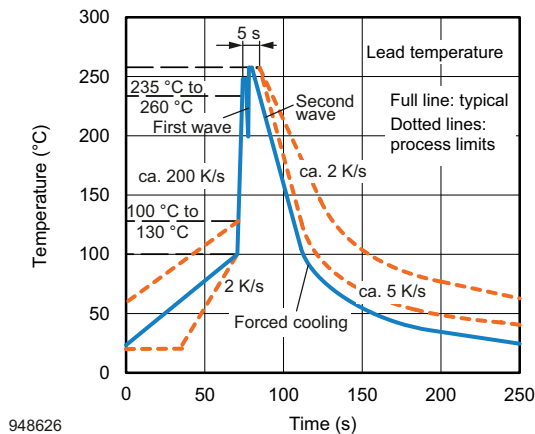


Fig. 19 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP Devices

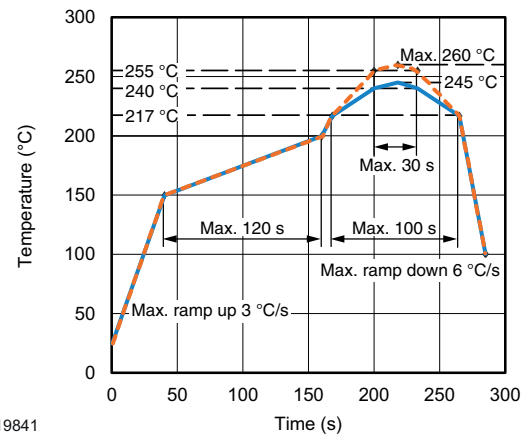


Fig. 20 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30\text{ °C}$, $RH < 60\%$

Moisture sensitivity level 1, according to J-STD-020



Footprint and Schematic Information for LH1540

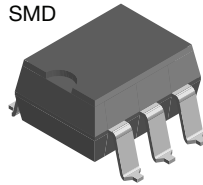
The footprint and schematic symbols for the following parts can be accessed using the associated links. They are available in Eagle, Altium, KiCad, OrCAD / Allegro, Pulsonix, and PADS.

Note that the 3D models for these parts can be found on the Vishay product page.

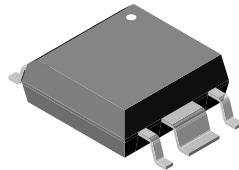
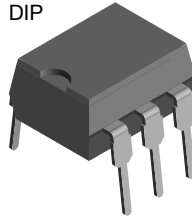
PART NUMBER	FOOTPRINT / SCHEMATIC
LH1540AAB	www.snapeda.com/parts/LH1540AAB/Vishay/view-part
LH1540AABTR	www.snapeda.com/parts/LH1540AABTR/Vishay/view-part
LH1540ACD	www.snapeda.com/parts/LH1540ACD/Vishay/view-part
LH1540ACDTR	www.snapeda.com/parts/LH1540ACDTR/Vishay/view-part
LH1540AT	www.snapeda.com/parts/LH1540AT/Vishay/view-part

For technical issues and product support, please contact optocoupleranswers@vishay.com.

SMD



DIP





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